



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



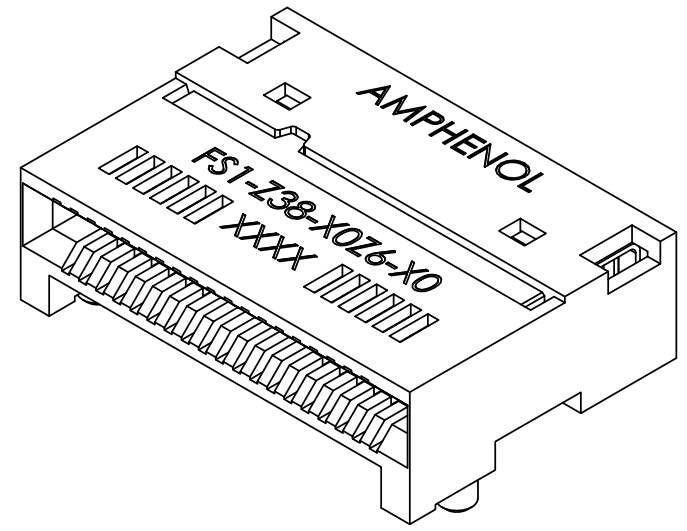
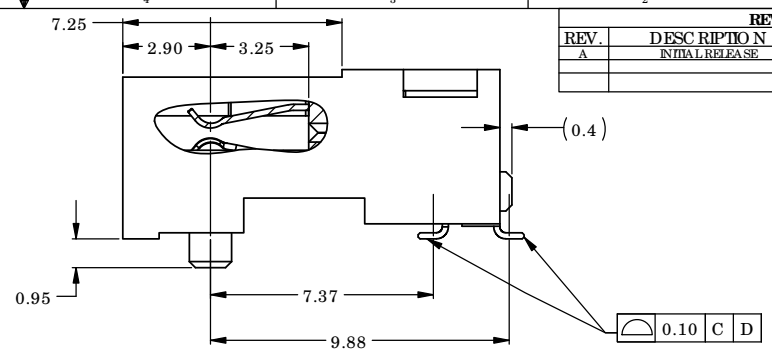
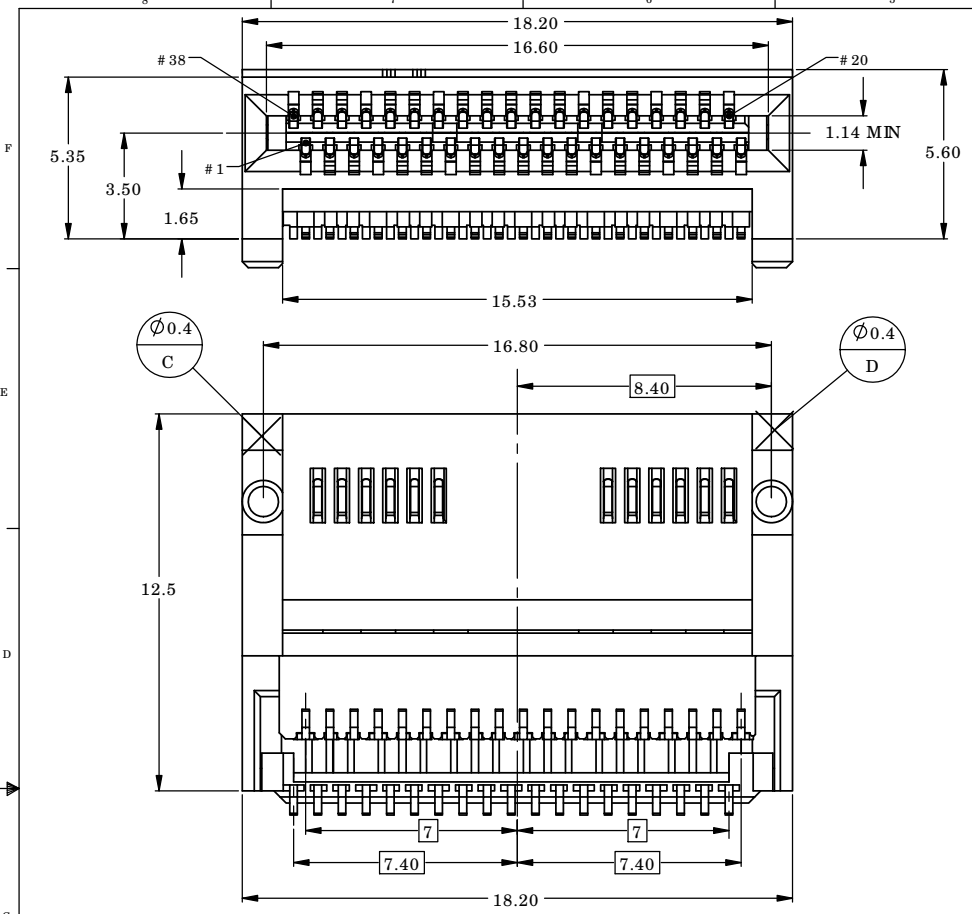
Contact us

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REVISIONS			
REV.	DESCRIPTION	DATE	APPROVED
A	INITIAL RELEASE	MAR 23/16	J. SI

FS1 - Z38 - X0Z6 - 60

CONTACT PLATING OPTION

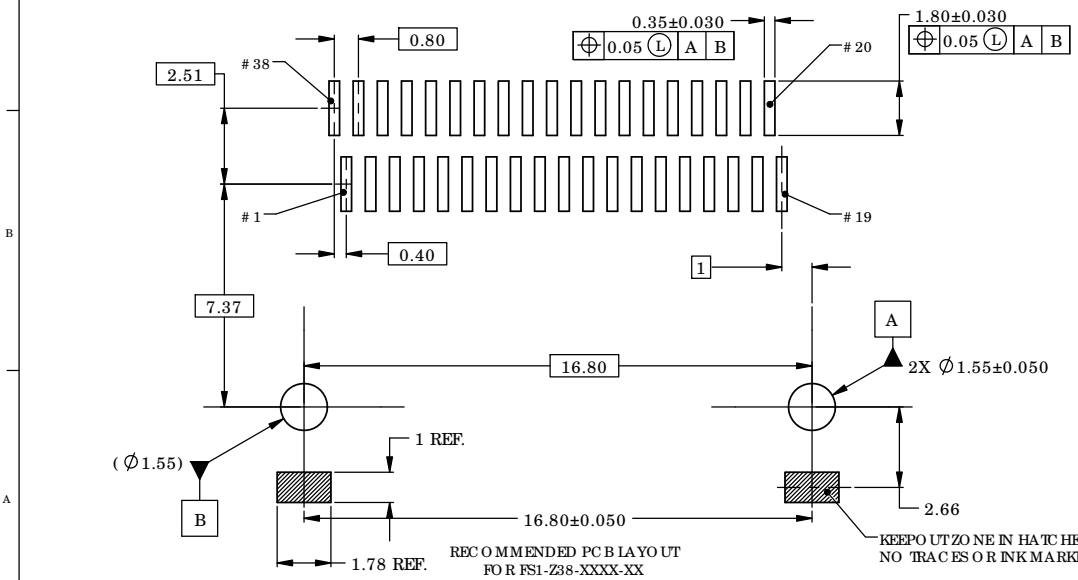
- 2** = 30 MICRO INCHES MINIMUM OF GOLD ON MATING END WITH 100 MICRO INCHES MINIMUM OF MATTE TIN ON SOLDER TERMINATION, 50 MIN. MICRO INCHES OF NICKEL UNDER PLATE ALL OVER
- 3** = 15 MICRO INCHES MINIMUM OF GOLD ON MATING END WITH 100 MICRO INCHES MINIMUM OF MATTE TIN ON SOLDER TERMINATION, 50 MIN. MICRO INCHES OF NICKEL UNDER PLATE ALL OVER

NOTES:

- 1) MATERIAL:
HOUSING: SOLDER REFLOW PROCESS COMPATIBLE LCP, UL94V-0
CONTACTS: PHOSPHOR BRONZE
RESONANCE DAMPENING FEATURE CONDUCTIVE POLYMER
- 2) ROHS COMPLIANT



DO NOT SCALE DRAWING



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UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MILLIMETERS			
APPROVALS	DATE	Amphenol High Speed Interconnects A Division of Amphenol Corp. www.amphenol-highspeed.com	
DRAWN: A. CHEN	MAR23/16	TITLE: Ultra Port Q SFP 4x28	
CHECKED: A. CHEN	MAR23/16	PART: 38 POSITION CONNECTOR	
QA APPROV: J. SI	MAR23/16	REV: C	REV: P-FS1-Z38-X0Z6-60
SA APPROV: J. PEN	MAR23/16	SCALE: NTS	REV: FS1
DRG. BELONG: ANDY CHEN	MAR23/16	DRG. NO: 03554	REV: A
DATE: 03/23/16	DRG. APPR: J. SI	DATE: MAR23/16	REV: 1 OF 1